PF08107BP

MOS FET Power Amplifier Module
for E-GSM and DCS1800 Dual Band Handy Phone

HITACHI

ADE-208-1399B (Z)
3rd Edition
Feb. 2001

Application

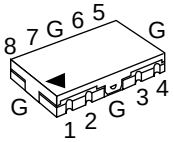
- Dual band amplifier for E-GSM (880 MHz to 915 MHz) and DCS1800 (1710 MHz to 1785 MHz).
- For 3.5 V nominal operation

Features

- 2 in / 2 out dual band amplifier
- Simple external circuit including output matching circuit
- One power control pin with one band switch
- High gain 3stage amplifier : 0 dBm input Typ
- Lead less thin & Small package : 8 × 13.75 × 1.6 mm Typ
- High efficiency : 46 % Typ at 35.0 dBm for E-GSM
  40 % Typ at 32.0 dBm for DCS1800

Pin Arrangement

• RF-K-8



1: Pin $_{GSM}$
2: Vapc
3: Vdd1
4: Pout $_{GSM}$
5: Pout $_{DCS}$
6: Vdd2
7: Vctl
8: Pin $_{DCS}$
G: GND

Hitachi semiconductor

Absolute Maximum Ratings (Tc = 25°C)

Item	Symbol	Rating	Unit
Supply voltage	Vdd	8	V
Supply current	Idd_{GSM}	3.5	A
	Idd_{DCS}	2	A
Vctl voltage	Vctl	4	V
Vapc voltage	Vapc	4	V
Input power	Pin	10	dBm
Operating case temperature	Tc (op)	–30 to +100	°C
Storage temperature	Tstg	–30 to +100	°C
Output power	$Pout_{GSM}$	37	dBm
	$Pout_{DCS}$	34.8	dBm

Note: The maximum ratings shall be valid over both the E-GSM-band (880 to 915 MHz), and the DCS1800-band (1710 to 1785 MHz).

Electrical Characteristics for DC (Tc = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Drain cutoff current	Ids	—	—	20	µA	Vdd = 4.7 V, Vapc = 0 V, Vctl = 0.2 V
		—	—	300	µA	Vdd = 8 V, Vapc = 0 V, Vctl = 0.2 V, Tc = –20 to +70°C
Vapc control current	Iapc	—	—	3	mA	Vapc = 2.2 V
Vctl control current	Ictl	—	—	2	µA	Vctl = 3 V

Electrical Characteristics for E-GSM mode (Tc = 25°C)

Test conditions unless otherwise noted:
f = 880 to 915 MHz, Vdd1 = Vdd2 = 3.5 V, Pin = 0 dBm, Vctl = 2.0 V, Rg = Rl = 50 Ω, Tc = 25°C,
Pulse operation with pulse width 577 µs and duty cycle 1:8 shall be used.

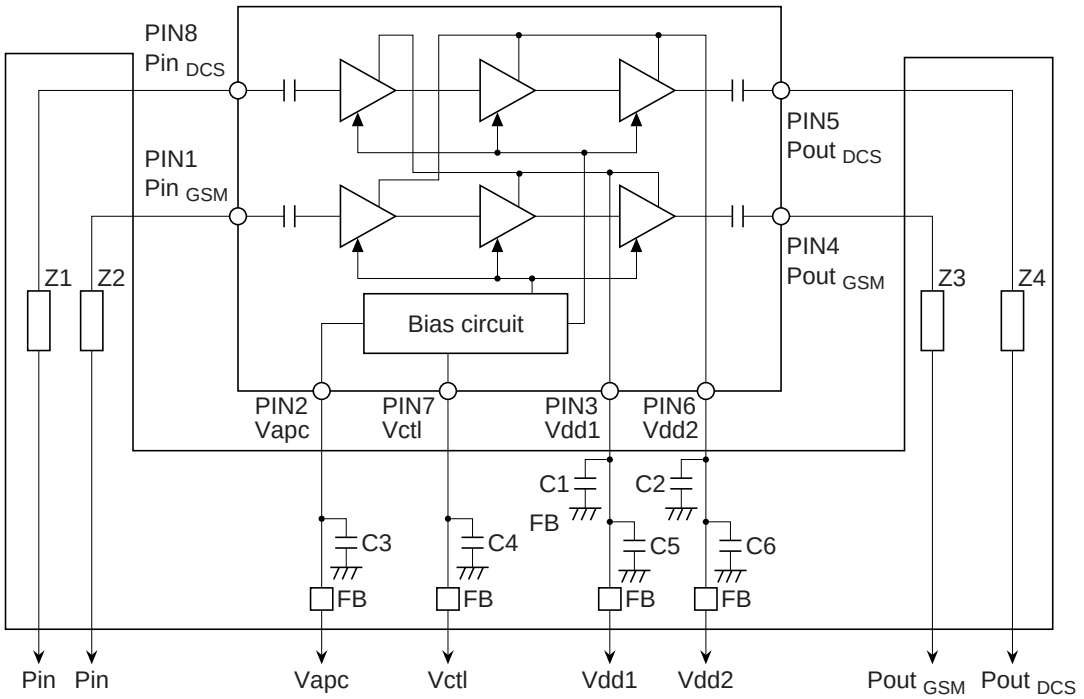
Item	Symbol	Min	Typ	Max	Unit	Test Condition
Frequency range	F	880	—	915	MHz	
Band select (GSM active)	Vctl	2.0	—	2.8	V	
Input power	Pin	–2	0	2	dBm	
Control voltage range	Vapc	0.2	—	2.2	V	
Supply voltage	Vdd	3.0	3.5	4.5	V	
Total efficiency	η_T	41	46	—	%	Pout $_{GSM}$ = 35 dBm,
2nd harmonic distortion	2nd H.D.	—	–45	–35	dBc	Vapc = controlled
3rd harmonic distortion	3rd H.D.	—	–45	–35	dBc	
4th~8th harmonic distortion	4th~8th H.D.	—	—	–35	dBc	
Input VSWR	VSWR (in)	—	1.5	3	—	
Output power (1)	Pout (1)	35.0	36.0	—	dBm	Vapc = 2.2 V
Output power (2)	Pout (2)	34.0	35.0	—	dBm	Vdd = 3.1 V, Vapc = 2.2 V, Tc = +70°C
Isolation	—	—	–42	–37	dBm	Vapc = 0.2 V, Pin = 2 dBm
Isolation at DCS RF-output when GSM is active	—	—	–30	–20	dBm	Pout $_{GSM}$ = 35 dBm, Measured at f = 1760 to 1830 MHz
Switching time	t_r, t_f	—	1	2	µs	Pout $_{GSM}$ = 0 to 35.0 dBm
Stability	—	No parasitic oscillation			—	Vdd = 3.1 to 4.5 V, Pout ≤ 35 dBm, Vapc $_{GSM}$ ≤ 2.2 V, Rg = 50 Ω, Tc = 25°C, Output VSWR = 6 : 1 All phases
Load VSWR tolerance	—	No degradation			—	Vdd = 3.1 to 4.5 V, Pout $_{GSM}$ ≤ 35 dBm, Vapc $_{GSM}$ ≤ 2.2 V, Rg = 50 Ω, t = 20 sec., Tc = 25°C, Output VSWR = 10 : 1 All phases

Electrical Characteristics for DCS1800 mode (Tc = 25°C)

Test conditions unless otherwise noted:
f = 1710 to 1785 MHz, Vdd1 = Vdd2 = 3.5 V, Pin = 0 dBm, Vctl = 0 V, Rg = Rl = 50 Ω, Tc = 25°C,
Pulse operation with pulse width 577 µs and duty cycle 1:8 shall be used.

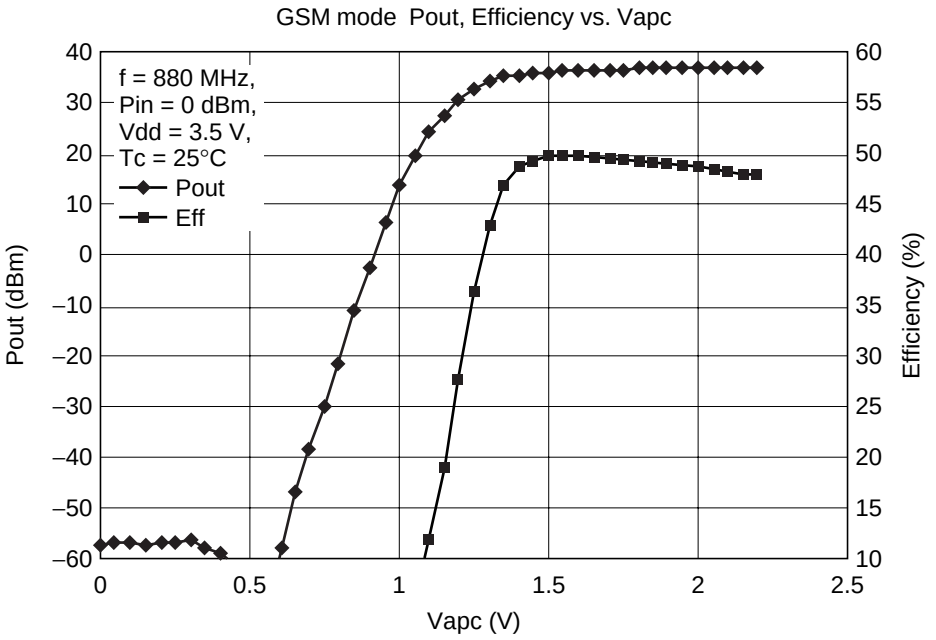
Item	Symbol	Min	Typ	Max	Unit	Test Condition
Frequency range	F	1710	—	1785	MHz	DCS1800 (1710 to 1785)
Band select (DCS active)	Vctl	0	—	0.1	V	
Input power	Pin	–2	0	2	dBm	
Control voltage range	Vapc	0.2	—	2.2	V	
Supply voltage	Vdd	3.0	3.5	4.5	V	
Total efficiency	η_T	34	40	—	%	Pout $_{DCS}$ = 32 dBm,
2nd harmonic distortion	2nd H.D.	—	–45	–35	dBc	Vapc = controlled
3rd harmonic distortion	3rd H.D.	—	–45	–35	dBc	
4th~8th harmonic distortion	4th~8th H.D.	—	—	–35	dBc	
Input VSWR	VSWR (in)	—	1.5	3	—	
Output power (1)	Pout (1)	32.5	33.5	—	dBm	Vapc = 2.2 V
Output power (2)	Pout (2)	31.0	32.0	—	dBm	Vdd = 3.1 V, Vapc = 2.2 V, Tc = +70°C
Isolation	—	—	–42	–37	dBm	Vapc = 0.2 V, Pin $_{DCS}$ = 2 dBm
Switching time	t_r, t_f	—	1	2	µs	Pout $_{DCS}$ = 0 to 32 dBm
Stability	—	No parasitic oscillation			—	Vdd = 3.1 to 4.5 V, Pout $_{DCS}$ ≤ 32 dBm, Vapc ≤ 2.2 V, Rg = 50 Ω, Output VSWR = 6 : 1 All phases
Load VSWR tolerance	—	No degradation			—	Vdd = 3.1 to 4.5 V, Pout $_{DCS}$ ≤ 32 dBm, Vapc ≤ 2.2 V, Rg = 50 Ω, t = 20 sec., Output VSWR = 10 : 1 All phases

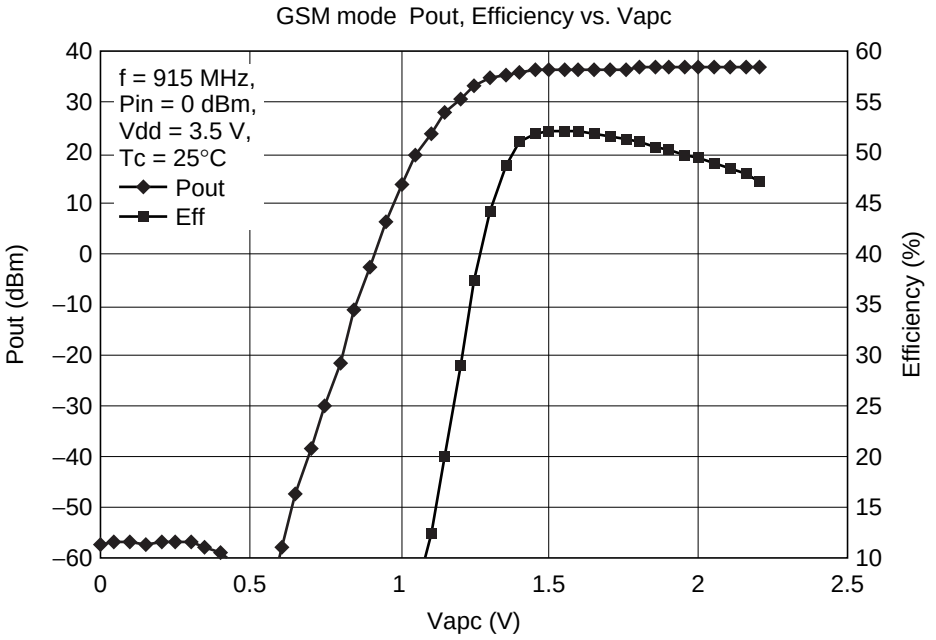
Internal Diagram and External Circuit

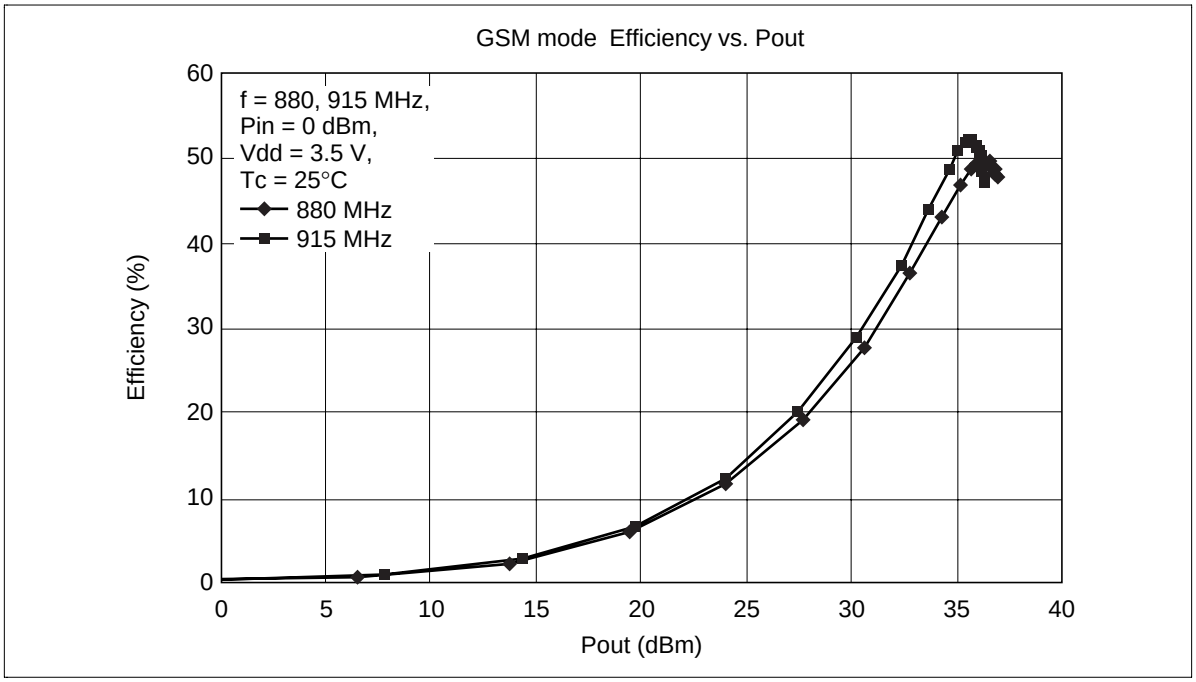


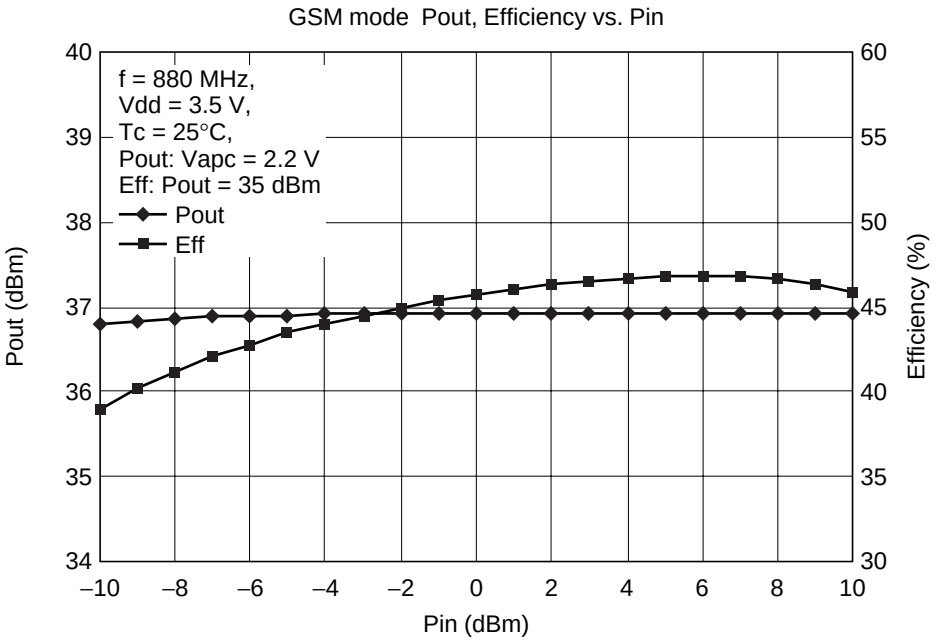
Note: C1 to C4 = 0.01 μF CERAMIC CHIP
C5 = C6 = 4.7 F TANTALUM ELECTROLYTE
FB = FERRITE BEAD BLO1RN1-A62-001 (MURATA) or equivalent
Z1 = Z2 = Z3 = Z4 = 50 Ω MICRO STRIP LINE

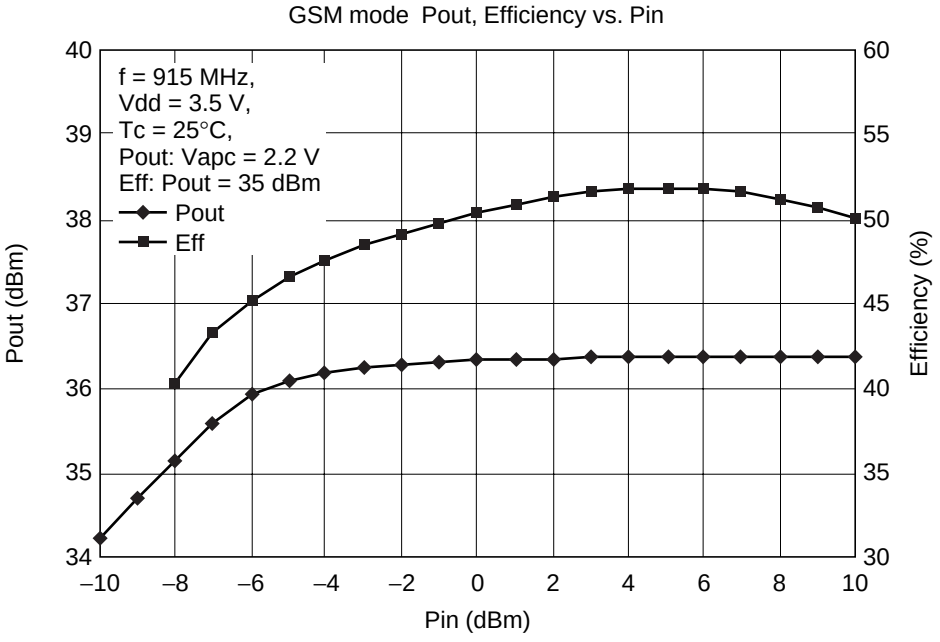
Characteristic Curves

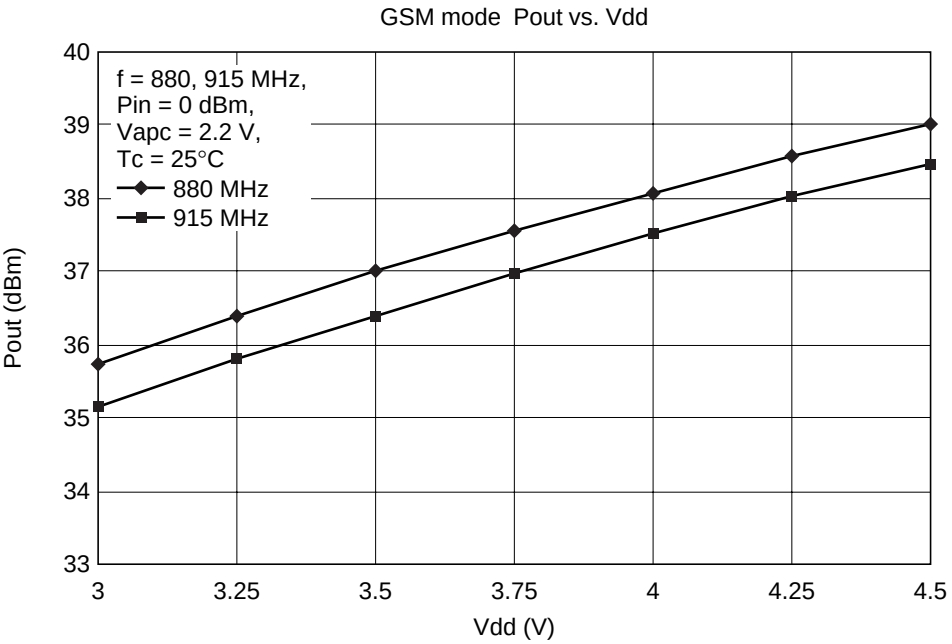


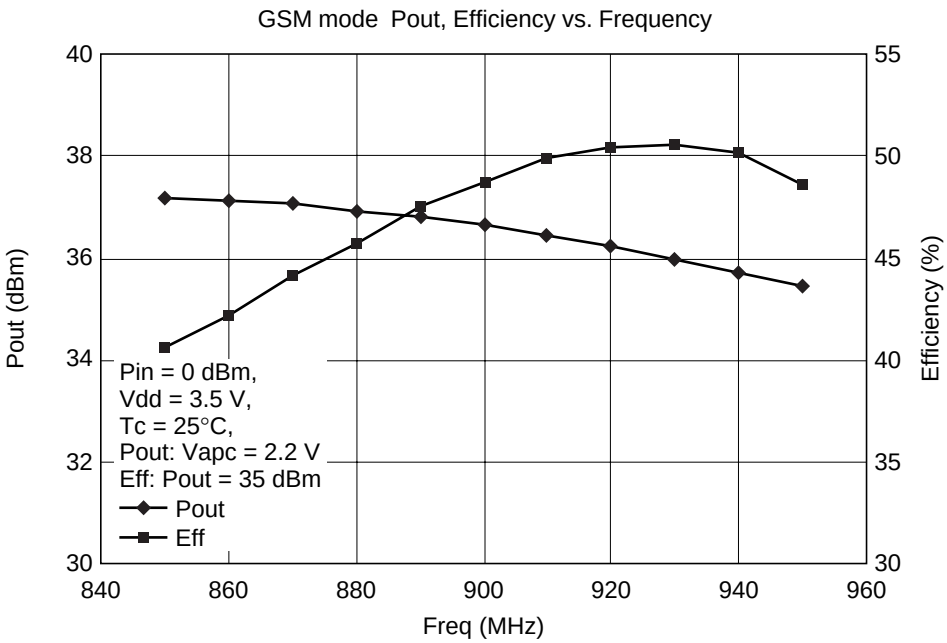



GSM mode Efficiency vs. Pout
f = 880, 915 MHz,
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C
880 MHz
915 MHz
Efficiency (%)
Pout (dBm)
0
10
20
30
40
50
60
0
5
10
15
20
25
30
35
40

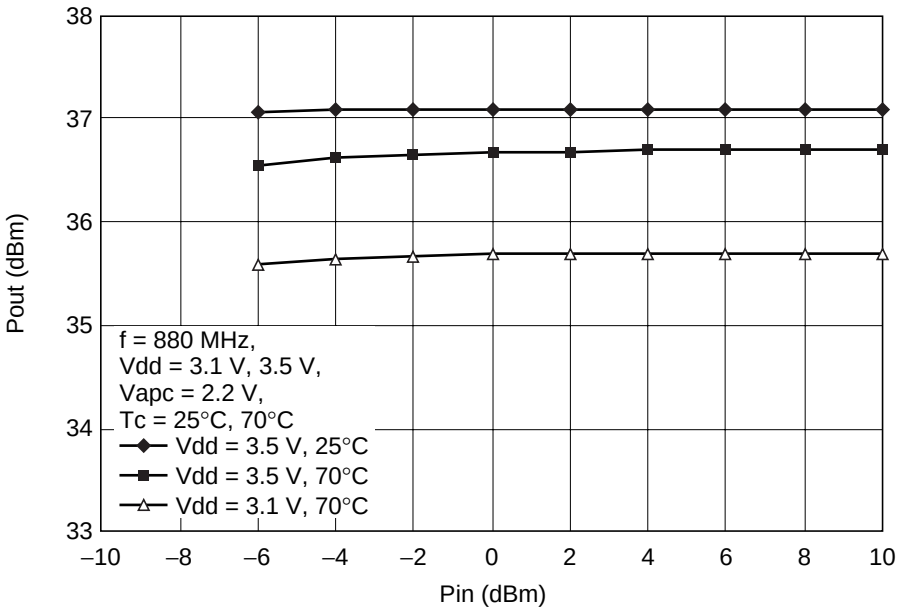

GSM mode Pout, Efficiency vs. Pin
f = 880 MHz,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 35 dBm
Pout
Eff
Pout (dBm)
Efficiency (%)
Pin (dBm)
40
39
38
37
36
35
34
60
55
50
45
40
35
30
–10
–8
–6
–4
–2
0
2
4
6
8
10


GSM mode Pout, Efficiency vs. Pin
f = 915 MHz,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 35 dBm
Pout
Eff
Pout (dBm)
Efficiency (%)
Pin (dBm)
40
39
38
37
36
35
34
60
55
50
45
40
35
30
–10
–8
–6
–4
–2
0
2
4
6
8
10

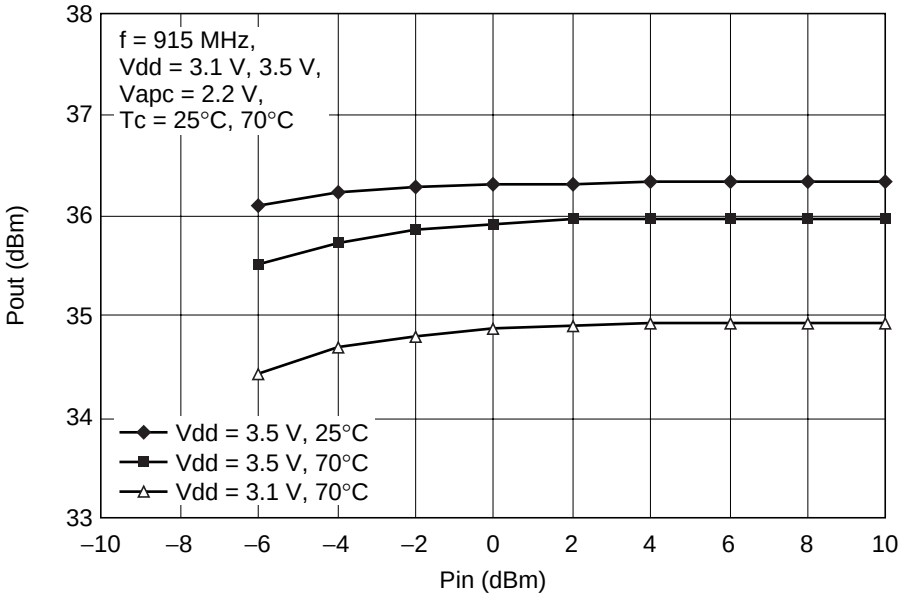

GSM mode Pout vs. Vdd
f = 880, 915 MHz,
Pin = 0 dBm,
Vapc = 2.2 V,
Tc = 25°C
880 MHz
915 MHz
Pout (dBm)
40
39
38
37
36
35
34
33
3
3.25
3.5
3.75
4
4.25
4.5
Vdd (V)

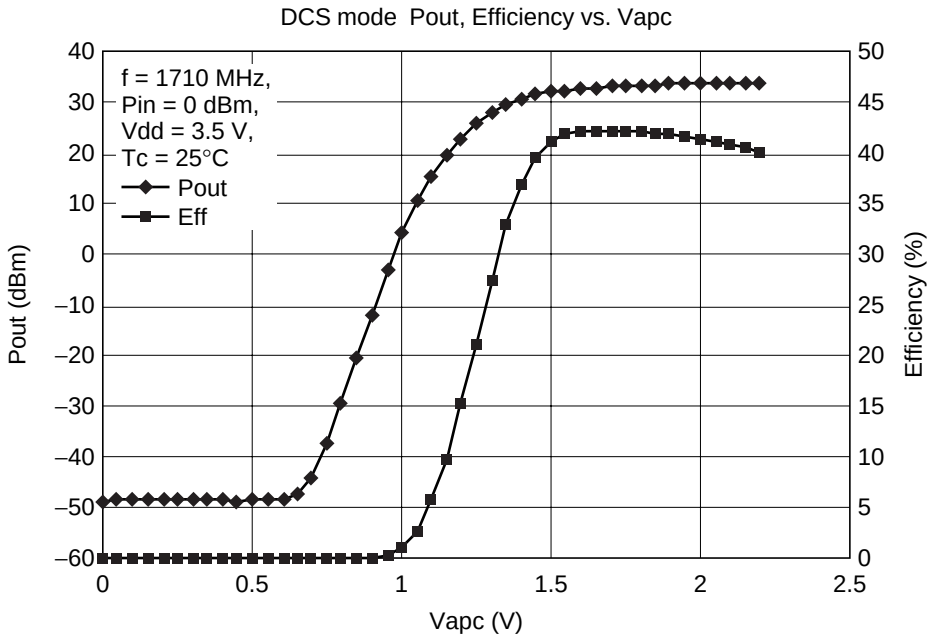

GSM mode Pout, Efficiency vs. Frequency
Pout (dBm)
Efficiency (%)
Freq (MHz)
40
38
36
34
32
30
55
50
45
40
35
30
840
860
880
900
920
940
960
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 35 dBm
Pout
Eff

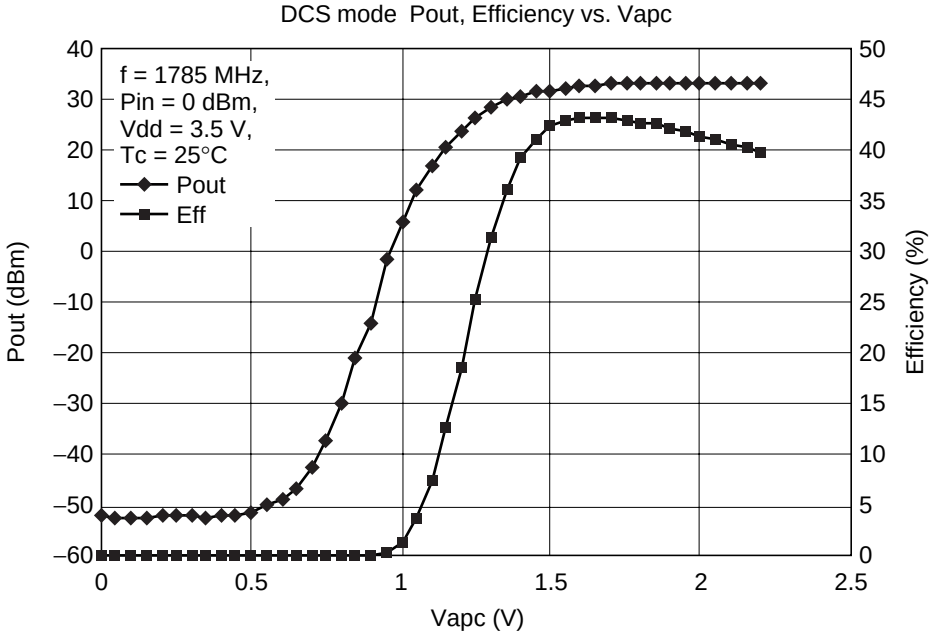
GSM mode Pout vs. Pin: Temperature variation

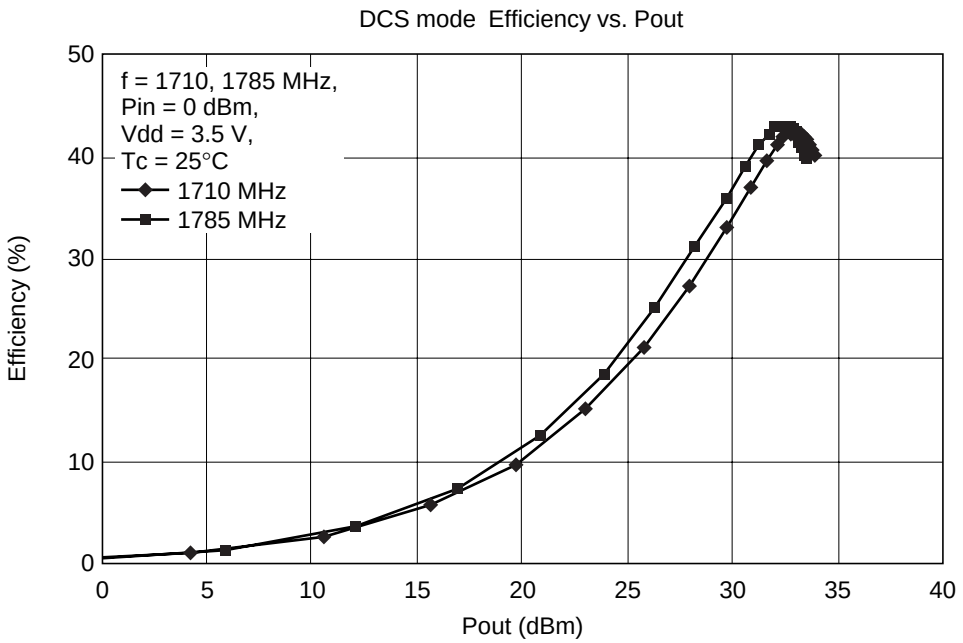


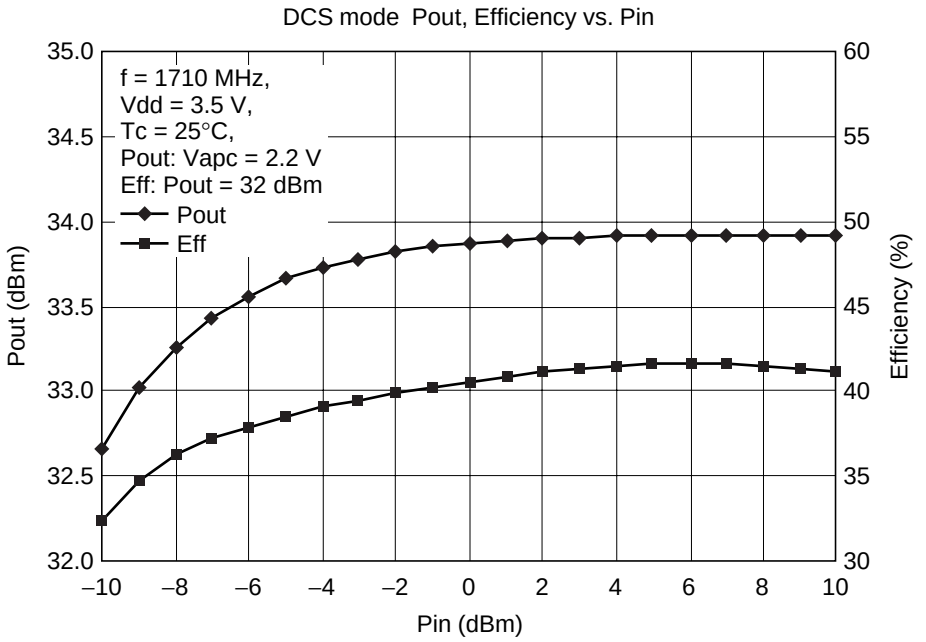
GSM mode Pout vs. Pin: Temperature variation

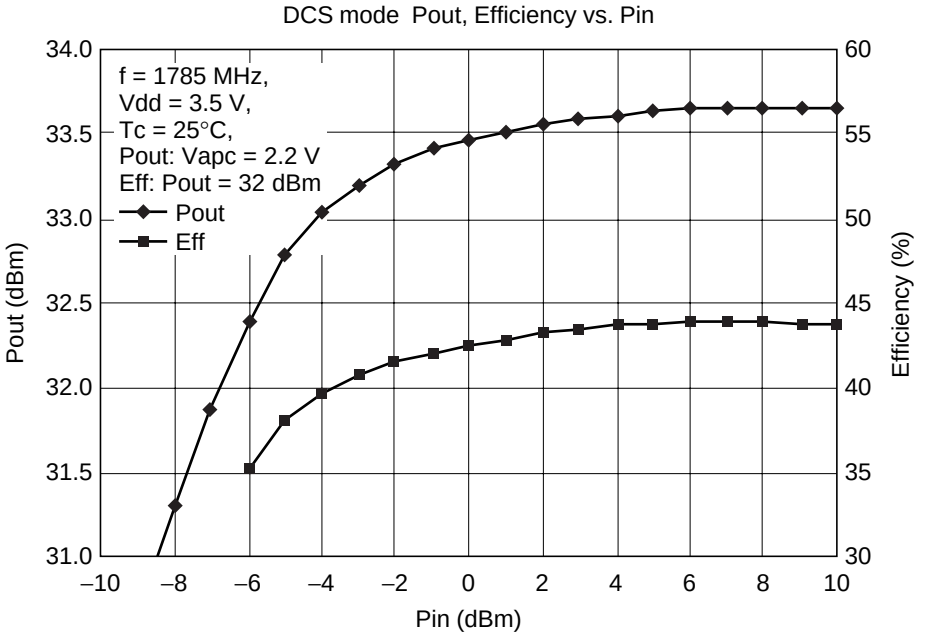


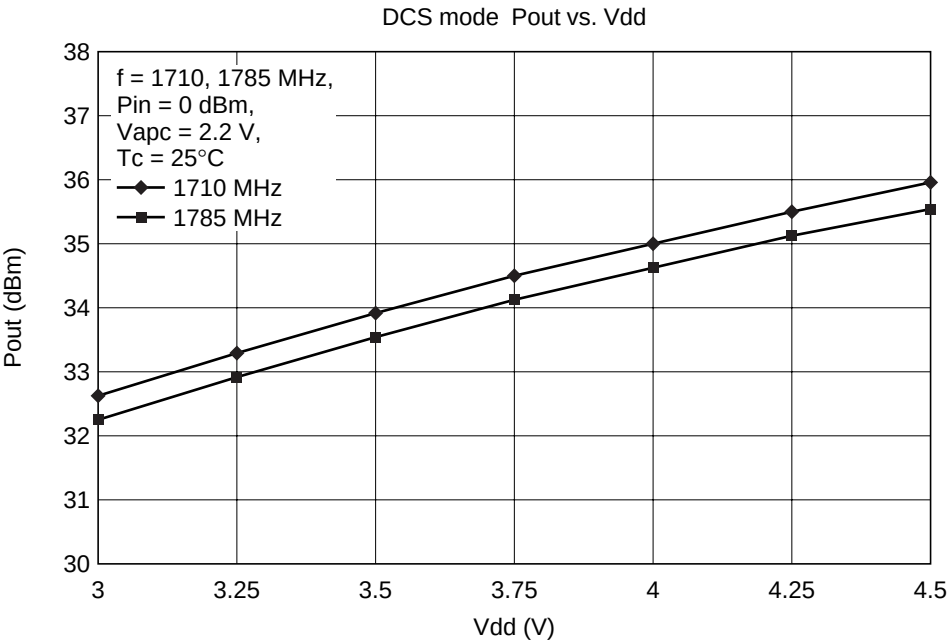

DCS mode Pout, Efficiency vs. Vapc
f = 1710 MHz,
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C
Pout
Eff
Pout (dBm)
Efficiency (%)
Vapc (V)
40
30
20
10
0
–10
–20
–30
–40
–50
–60
50
45
40
35
30
25
20
15
10
5
0
0
0.5
1
1.5
2
2.5

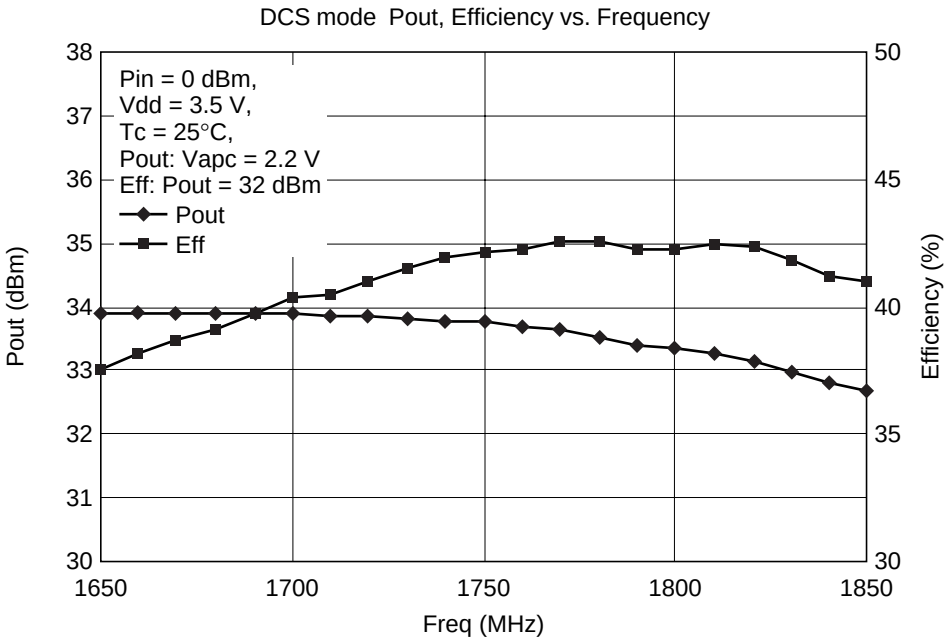

DCS mode Pout, Efficiency vs. Vapc
f = 1785 MHz,
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C
Pout
Eff
Pout (dBm)
Efficiency (%)
Vapc (V)
40
30
20
10
0
–10
–20
–30
–40
–50
–60
50
45
40
35
30
25
20
15
10
5
0
0
0.5
1
1.5
2
2.5


DCS mode Efficiency vs. Pout
f = 1710, 1785 MHz,
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C
1710 MHz
1785 MHz
Efficiency (%)
Pout (dBm)
0
10
20
30
40
50
0
5
10
15
20
25
30
35
40

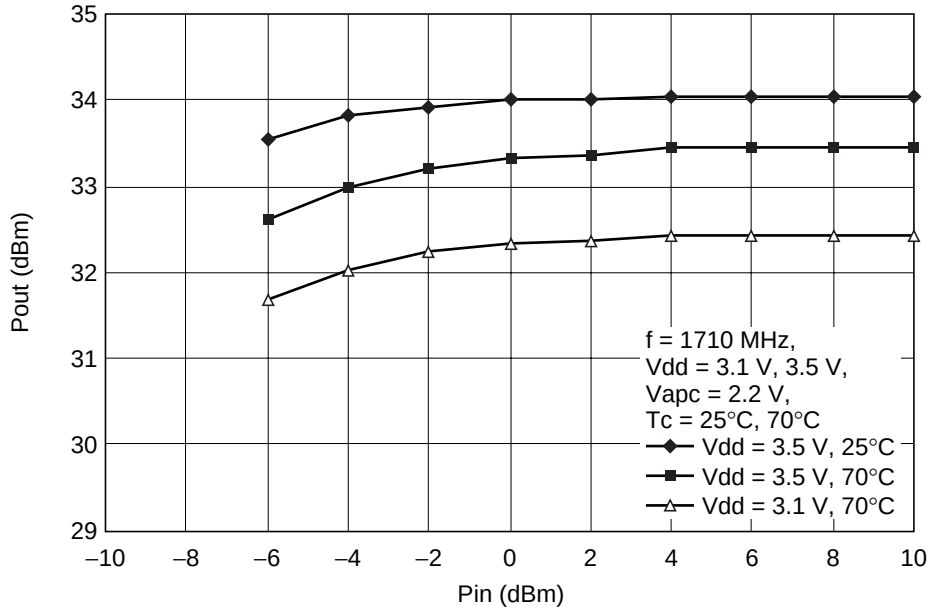

DCS mode Pout, Efficiency vs. Pin
f = 1710 MHz,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 32 dBm
Pout
Eff
Pout (dBm)
Efficiency (%)
Pin (dBm)
35.0
34.5
34.0
33.5
33.0
32.5
32.0
60
55
50
45
40
35
30
–10
–8
–6
–4
–2
0
2
4
6
8
10


DCS mode Pout, Efficiency vs. Pin
f = 1785 MHz,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 32 dBm
Pout
Eff
Pout (dBm)
Efficiency (%)
Pin (dBm)
34.0
33.5
33.0
32.5
32.0
31.5
31.0
60
55
50
45
40
35
30
–10
–8
–6
–4
–2
0
2
4
6
8
10

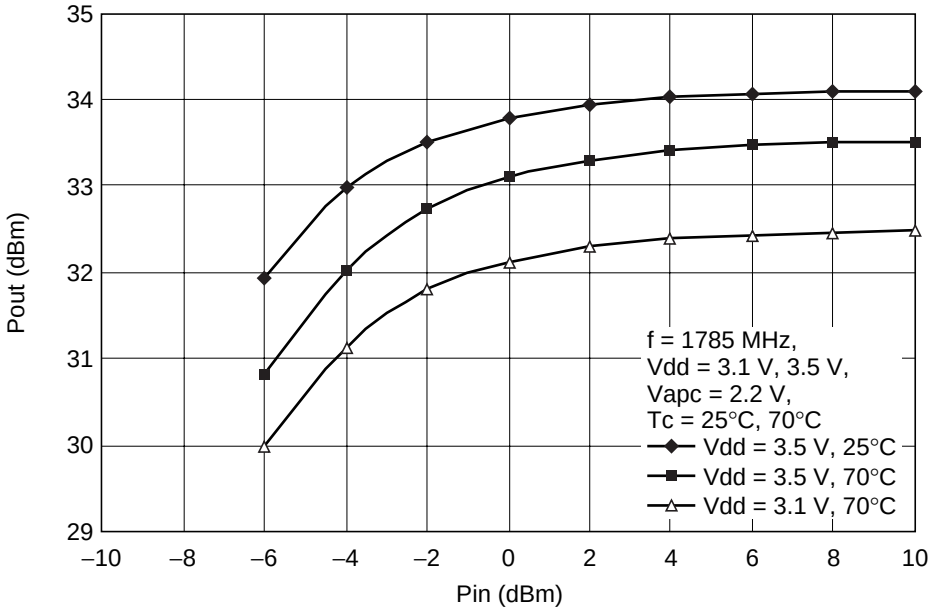

DCS mode Pout vs. Vdd
f = 1710, 1785 MHz,
Pin = 0 dBm,
Vapc = 2.2 V,
Tc = 25°C
1710 MHz
1785 MHz
Pout (dBm)
38
37
36
35
34
33
32
31
30
3
3.25
3.5
3.75
4
4.25
4.5
Vdd (V)


DCS mode Pout, Efficiency vs. Frequency
Pin = 0 dBm,
Vdd = 3.5 V,
Tc = 25°C,
Pout: Vapc = 2.2 V
Eff: Pout = 32 dBm
Pout
Eff
Pout (dBm)
Efficiency (%)
Freq (MHz)
38
37
36
35
34
33
32
31
30
50
45
40
35
30
1650
1700
1750
1800
1850

DCS mode Pout vs. Pin: Temperature variation

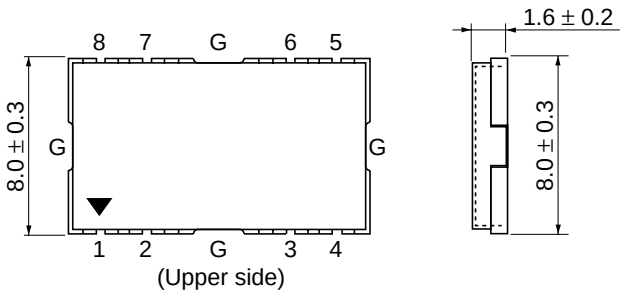


DCS mode Pout vs. Pin: Temperature variation

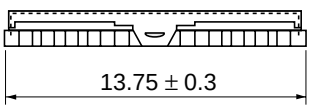


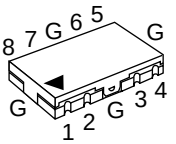
Package Dimensions

Unit: mm

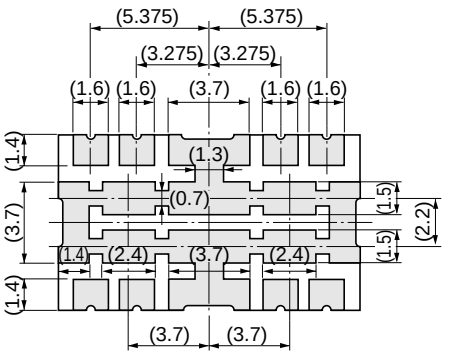


(Upper side)





1: Pin $_{GSM}$
2: Vapc
3: Vdd1
4: Pout $_{GSM}$
5: Pout $_{DCS}$
6: Vdd2
7: Vctl
8: Pin $_{DCS}$
G: GND



(Bottom side)

Remark:
Coplanarity of bottom side of terminals are less than 0 ± 0.1mm.

Hitachi Code	RF-K-8
JEDEC	—
EIAJ	—
Mass (reference value)	—

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